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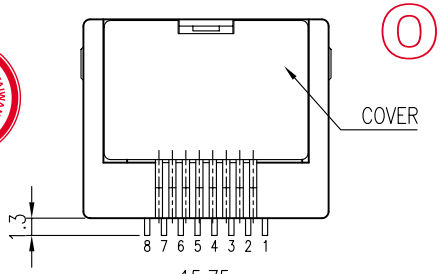
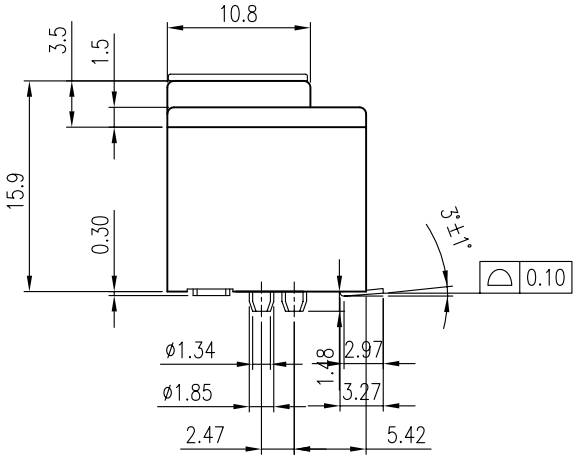
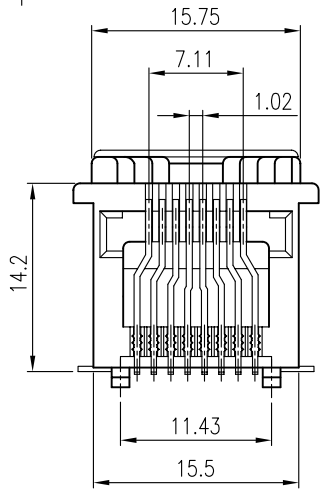
The marking on thisproduct doesn't contain environmental hazardous materials per Material Specification SS-00259 for Sony GP compliant or per directive 2002/95/EC for RoHS compliant.

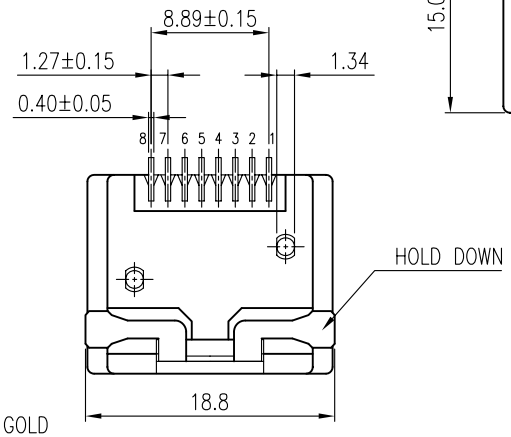
ORIGINAL

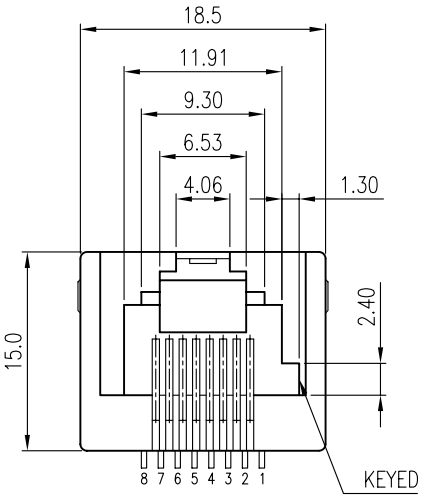
REVISIONS				
SYM	ECN No.	DESCRIPTION	DATE	APPROVED
A		RELEASE TO PRODUCTION	10/30/2008	Hank Hsu
B	NE-08392	MODIFIED DRAWING	11/18/2008	Hank Hsu



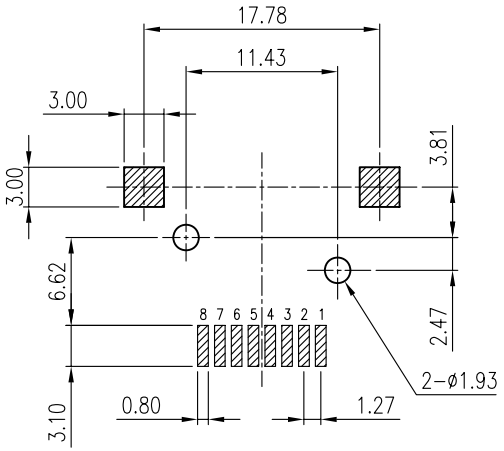








NON-COVER



RECOMMRNDED PCB LAYOUT- TOP VIEW
(GENERAL TOLERANCE: ±0.05)

G71B 0142 4 00 EU	50µ"
G71B 0142 3 00 EU	30µ"
G71B 0142 2 00 EU	15µ"
G71B 0142 1 00 EU	6µ"
PART NUMBER	FINISH

NOTES:
1. INSULATOR: NYLON 9T, UL 94V-0, COLOR- BLACK
2. CONTACT: PHOSPHOR BRONZE, 0.35 MM THICKNESS, SELECTIVE GOLD PLATED ON CONTACT AREA, GOLD FLASH PLATED ON SOLDERING AREA, 50µ" MIN. NICKEL UNDER-PLATING OVERALL
3. HOLD DOWN: COPPER ALLOY, 0.4MM THICKNESS, 100µ" MIN. TIN OVER 50µ" MIN. NICKEL UNDER-PLATING OVERALL
4. COVER: NYLON-46, UL 94V-0, COLOR- BLACK
5. THIS PRODUCT DOESN'T CONTAIN ENVIRONMENTAL HAZARDOUS MATERIAL PER DIRECTIVE 2002/95/EC FOR RoHS.
6. THE PRODUCT MUST BE PER Amphenol PACKING SPECIFICATION PKS-0001

TOLERANCE	APPROVALS	DATE
X.	DRAWN Sondra Sang	11/18/08
X.X ±0.30	CHECKED Roger Tsai	11/18/08
X.XX ±0.20	APPROVED Hank Hsu	11/18/08
X.XXX ±0.10	DWG TYPE CUST DWG	PROJECT CODE MJK
ANGULAR ±1°		
UNLESS OTHERWISE SPECIFIED		

TITLE: MODULAR JACK, 8P8C
TOP ENTRY, SMT, W/ KEYED
W/ HOLD DOWN & COVER

Amphenol ®
Amphenol Corporation
Amphenol Taiwan Corporation

UNIT mm | SIZE A3 | SCALE NA | SHEET 1 OF 1

PART No. G71B 0142X 00 EU

DWG No. G71B0142X00EU | REV. B